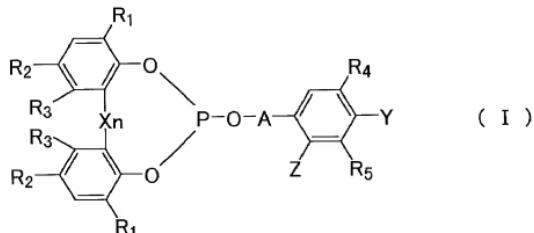


CLAIMS

1. A polypropylene resin composition for a metallized film, which comprises 100 parts by weight of a polypropylene resin and 0.01 to 1 part by weight of a phosphite represented by the general formula (I):



(wherein, R¹, R², R⁴ and R⁵ represent individually a hydrogen atom, alkyl group having 1 to 8 carbon atoms, cycloalkyl group having 5 to 8 carbon atoms, alkylcycloalkyl group having 6 to 12 carbon atoms, aralkyl group having 7 to 12 carbon atoms or phenyl group, respectively ; R³ represents a hydrogen atom or alkyl group having 1 to 8 carbon atoms; X represents sulfur atom or a -CHR⁶- group (R⁶ represents hydrogen atom, an alkyl group having 1 to 8 carbon atoms or a cycloalkyl group having 5 to 8 carbon atoms); n is 0 or 1; A is an alkylene group with 2 to 8 carbon atoms or a *-CO(R⁷)_m- group (R⁷ is an alkylene group with 1 to 8 carbon atoms, * mark is indicative of the bonding site of A to oxygen atom and m is 0 or 1); and either one of Y or Z is a hydroxy group, alkoxy group having 1 to 8 carbon atoms, or an aralkyloxy group having 7 to 12 carbon atoms and the other is a hydrogen atom or alkyl group having 1 to 8 carbon atoms.)

2. The polypropylene resin composition according to
claim 1, wherein the amount of the phosphite is 0.01 to 0.5
parts by weight.

3. A polypropylene resin composition film for
5 metallization made of the polypropylene resin composition of
claim 1.

4. The polypropylene resin composition film according
to Claim 3, wherein the polypropylene resin film is a
polypropylene resin composition film for aluminum
10 metallization.

5. A metallized polypropylene resin composition film
obtained by depositing a metallic substance on the surface
of the polypropylene resin composition film of claim 3.

6. The metallized polypropylene resin composition
15 film according to claim 5, wherein the metallic substance is
aluminum.